Zibo Seno Electronic Engineering Co., Ltd.

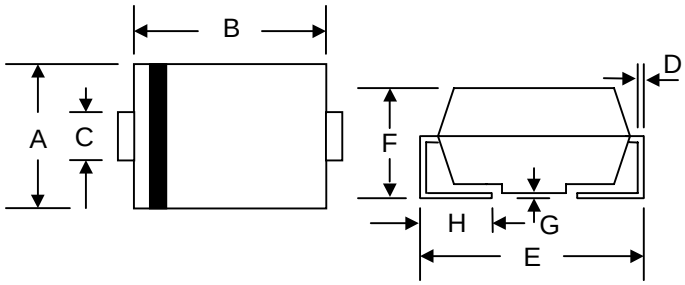
淄博圣诺

B220 – B2200

2.0A SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Schottky Barrier Chip
- Ideally Suited for Automatic Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 50A Peak
- For Use in Low Voltage Application
- Guard Ring Die Construction
- Plastic Case Material has UL Flammability Classification Rating 94V-O



Mechanical Data

- Case: SMB/DO-214AA, Molded Plastic
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number
- Weight: 0.093 grams (approx.)
- **Lead Free: For RoHS / Lead Free Version**

SMB/DO-214AA		
Dim	**Min**	**Max**
A	3.30	3.94
B	4.06	4.57
C	1.96	2.21
D	0.15	0.31
E	5.00	5.59
F	2.00	2.62
G	0.10	0.20
H	0.76	1.52
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

Characteristic	Symbol	B220	B230	B240	B250	B260	B280	B2100	B2150	B2200	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	50	60	80	100	150	200	V
RMS Reverse Voltage	$V_{R(RMS)}$	14	21	28	35	42	56	70	105	140	V
Average Rectified Output Current @T_L = 75°C	I_O	2.0									A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	50									A
Forward Voltage @I_F = 2.0A	V_{FM}	0.55			0.70		0.85		0.90		V
Peak Reverse Current @T_A = 25°C At Rated DC Blocking Voltage @T_A = 100°C	I_{RM}	0.5 20									mA
Typical Thermal Resistance (Note 1)	$R_{\theta JL}$ $R_{\theta JA}$	28 88									°C/W
Operating Temperature Range	T_j	-55 to +150									°C
Storage Temperature Range	T_{STG}	-55 to +150									°C

Note: 1. Mounted on P.C. Board with 5.0mm^2 copper pad area.

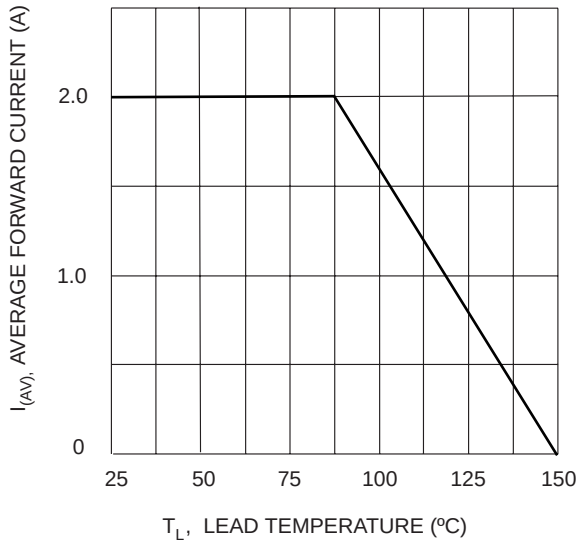


Fig. 1 Forward Current Derating Curve

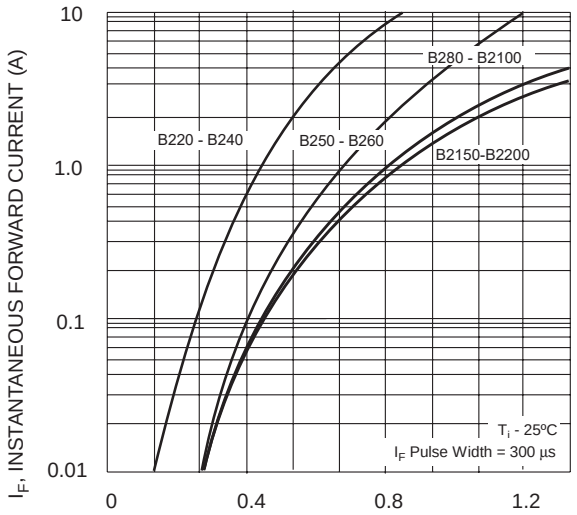


Fig. 2 Typ. Forward Characteristics

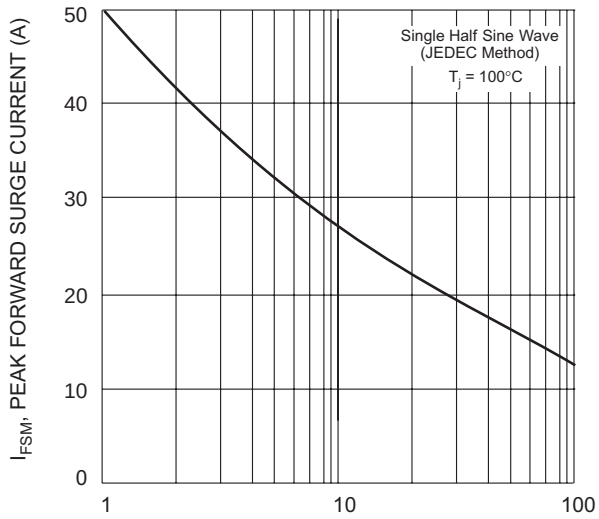


Fig. 3 Max Non Repetitive Peak Fwd Surge Current

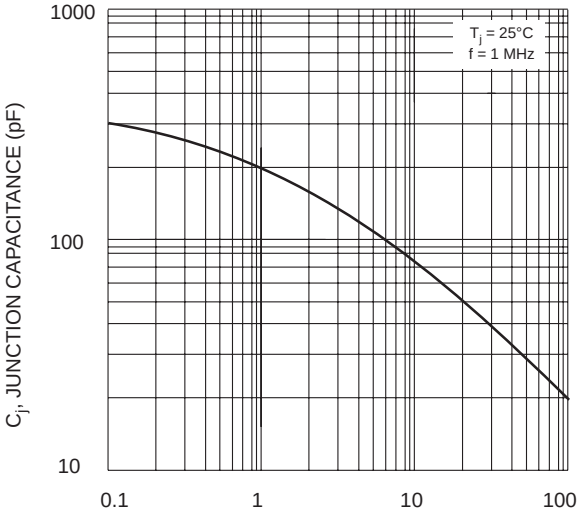


Fig. 4 Typical Junction Capacitance

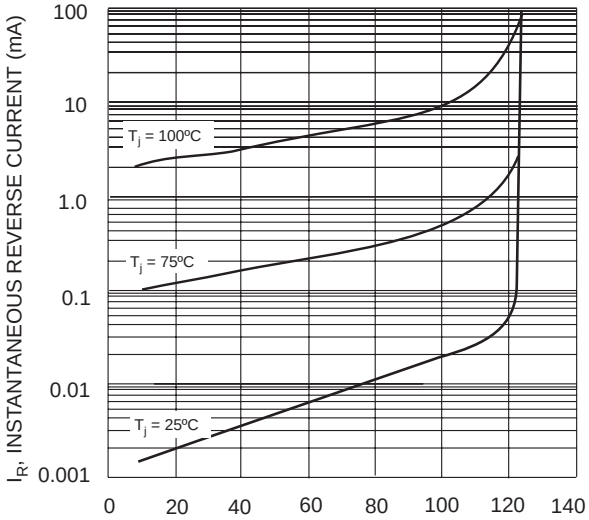


Fig. 5 Typical Reverse Characteristics